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FDP8874

N-Channel PowerTrench[®] MOSFET 30V, 114A, 5.3m Ω

General Description

This N-Channel MOSFET has been designed specifically to improve the overall efficiency of DC/DC converters using either synchronous or conventional switching PWM controllers. It has been optimized for low gate charge, low $r_{\text{DS}(\text{ON})}$ and fast switching speed.

Applications

DC/DC converters



Features

- $r_{DS(ON)} = 5.3m\Omega$, $V_{GS} = 10V$, $I_D = 40A$
- $r_{DS(ON)} = 6.6m\Omega$, $V_{GS} = 4.5V$, $I_D = 40A$
- High performance trench technology for extremely low $r_{\mbox{DS}(\mbox{ON})}$
- Low gate charge
- High power and current handling capability
- RoHS Compliant



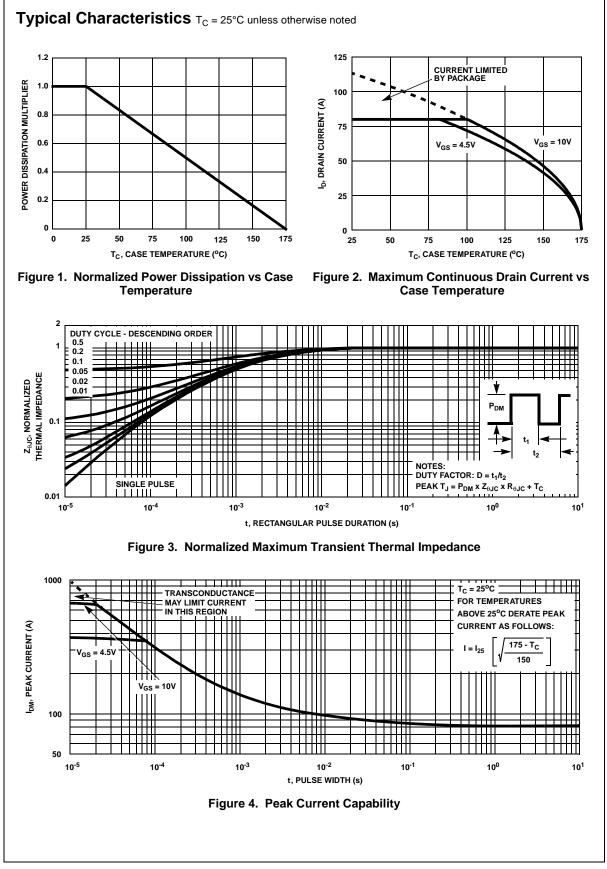
FDP SERIES

MOSFET Maximum Ratings T_C = 25°C unless otherwise noted

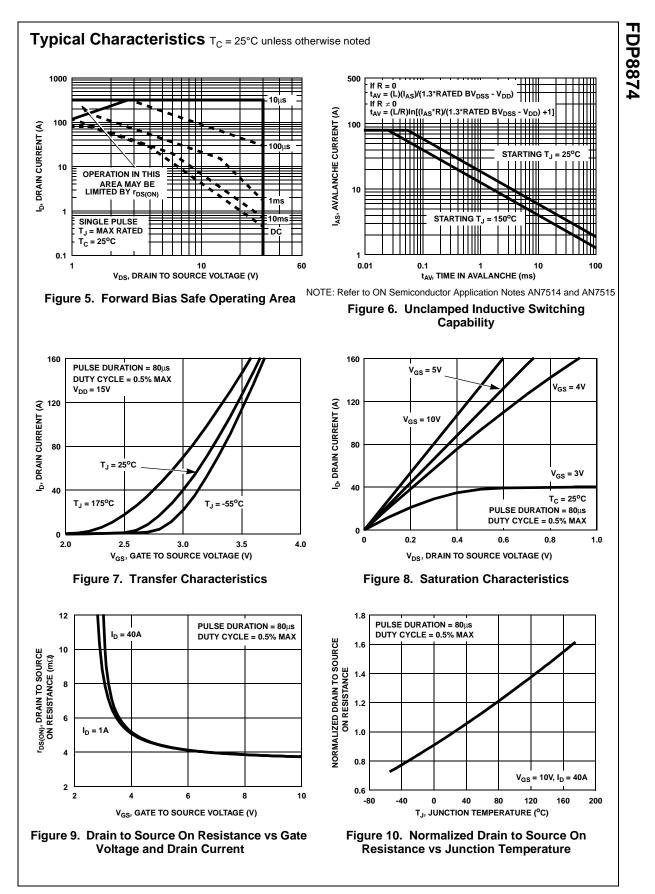
Symbol	Parameter	Ratings	Units
/ _{DSS}	Drain to Source Voltage	30	V
/ _{GS}	Gate to Source Voltage	±20	V
I _D	Drain Current		
	Continuous ($T_C = 25^{\circ}C$, $V_{GS} = 10V$) (Note 1)	114	Α
	Continuous ($T_C = 25^{\circ}C$, $V_{GS} = 4.5V$) (Note 1)	102	A
	Continuous ($T_{amb} = 25^{\circ}C$, $V_{GS} = 10V$, with $R_{\theta JA} = 62^{\circ}C/W$)	16	Α
	Pulsed	Figure 4	A
AS	Single Pulse Avalanche Energy (Note 2)	105	mJ
P _D	Power dissipation	110	W
	Derate above 25°C	0.73	W/ºC
J, T _{STG}	Operating and Storage Temperature	-55 to 175	°C
herma	Characteristics Thermal Resistance Junction to Case TO-220	1.36	°C/V
	Thermal Resistance Junction to Ambient TO-220 (Note 3)	62	°C/V

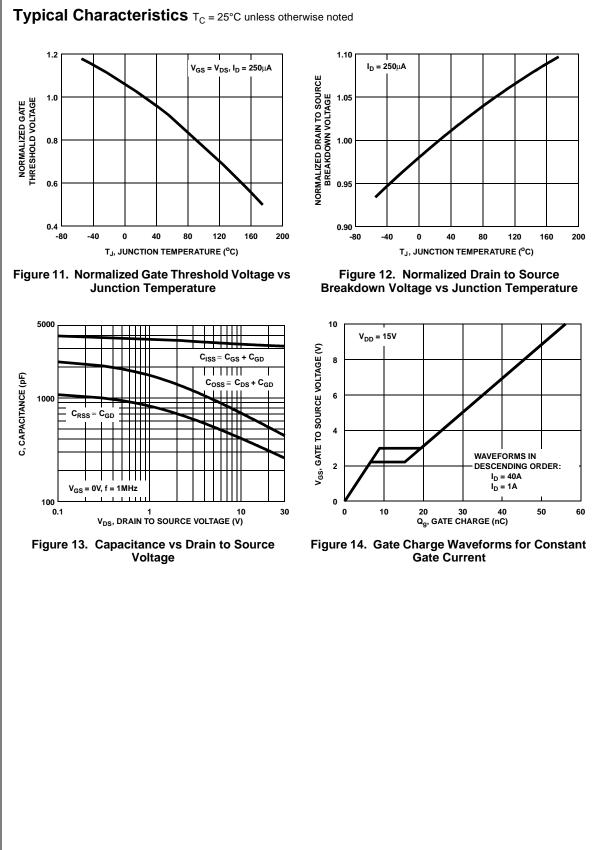
Device Marking	Device	Package	Reel Size	Tape Width	Quantity	
FDP8874	FDP8874	TO-220AB	Tube	N/A	50 units	

Symbol	Parameter	Test Conditions	Min	Тур	Мах	Units
Off Chara	acteristics					
B _{VDSS}	Drain to Source Breakdown Voltage	I _D = 250μA, V _{GS} = 0V	30	-	-	V
-1055		$V_{DS} = 24V$	-	-	1	•
IDSS	Zero Gate Voltage Drain Current	$V_{GS} = 0V$ $T_C = 150^{\circ}C$	-	-	250	μA
I _{GSS}	Gate to Source Leakage Current	V _{GS} = ±20V	-	-	±100	nA
On Chara	acteristics					
V _{GS(TH)}	Gate to Source Threshold Voltage	$V_{GS} = V_{DS}, I_D = 250 \mu A$	1.2	-	2.5	V
r _{DS(ON)}	Drain to Source On Resistance	$I_{\rm D} = 40$ A, $V_{\rm GS} = 10$ V			0.0053	;
		$I_D = 40A, V_{GS} = 4.5V$	-	0.0045	0.0066	Ω
		$I_D = 40A, V_{GS} = 10V,$ $T_J = 175^{\circ}C$	-	0.0062	0.0090	
Dynamic	Characteristics					
C _{ISS}	Input Capacitance		-	3130	-	pF
C _{OSS}	Output Capacitance	$V_{\text{DS}} = 15 \text{V}, V_{\text{GS}} = 0 \text{V},$	_	590	-	pF
C _{RSS}	Reverse Transfer Capacitance	f = 1MHz	-	345	-	pF
R _G	Gate Resistance	V _{GS} = 0.5V, f = 1MHz	-	1.9	-	Ω
Q _{g(TOT)}	Total Gate Charge at 10V	$V_{GS} = 0V$ to 10V	-	56	72	nC
Q _{g(5)}	Total Gate Charge at 5V	$V_{CS} = 0V$ to 5V	-	30	38	nC
Q _{g(TH)}	Threshold Gate Charge	$V_{DD} = 15V$	-	3.0	4.0	nC
Q _{gs}	Gate to Source Gate Charge	·D ··•·	-	9.0	-	nC
Q _{gs2}	Gate Charge Threshold to Plateau	I _g = 1.0mA	-	6.0	-	nC
Q _{gd}	Gate to Drain "Miller" Charge	_	-	11	-	nC
	g Characteristics (V _{GS} = 10V)					
t _{ON}	Turn-On Time		-	-	207	ns
t _{d(ON)}	Turn-On Delay Time	_	-	10	-	ns
t _r	Rise Time	V _{DD} = 15V, I _D = 40A	-	128	-	ns
t _{d(OFF)}	Turn-Off Delay Time	$V_{GS} = 4.5V, R_{GS} = 4.7\Omega$	-	44	-	ns
t _f	Fall Time	_	-	31	-	ns
t _{OFF}	Turn-Off Time	_	-	-	112	ns
Drain-So	urce Diode Characteristics					
V _{SD}	Source to Drain Diode Voltage	I _{SD} = 40A	-	-	1.25	V
		$I_{SD} = 20A$	-	-	1.0	V
+	Reverse Recovery Time	$I_{SD} = 40A$, $dI_{SD}/dt = 100A/\mu s$	-	-	32	ns
t _{rr}	Reverse Recovered Charge	$I_{SD} = 40A$, $dI_{SD}/dt = 100A/\mu s$	-	-	18	nC



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VARY t_P TO OBTAIN REQUIRED PEAK I_{AS} V_{GS} V_{GS} V_{GS} UT I_{AS} 0.01Ω

Test Circuits and Waveforms

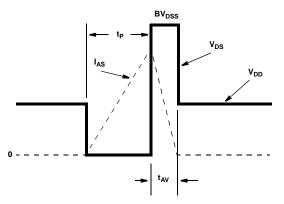


Figure 15. Unclamped Energy Test Circuit

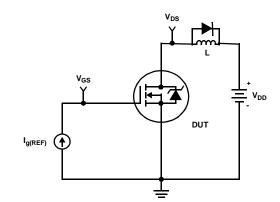


Figure 17. Gate Charge Test Circuit

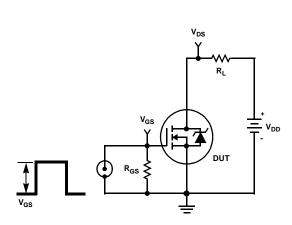


Figure 19. Switching Time Test Circuit

Figure 16. Unclamped Energy Waveforms

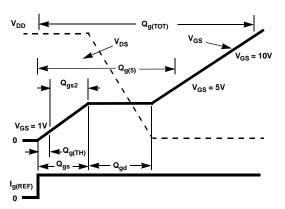


Figure 18. Gate Charge Waveforms

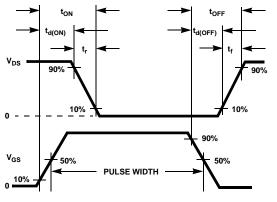
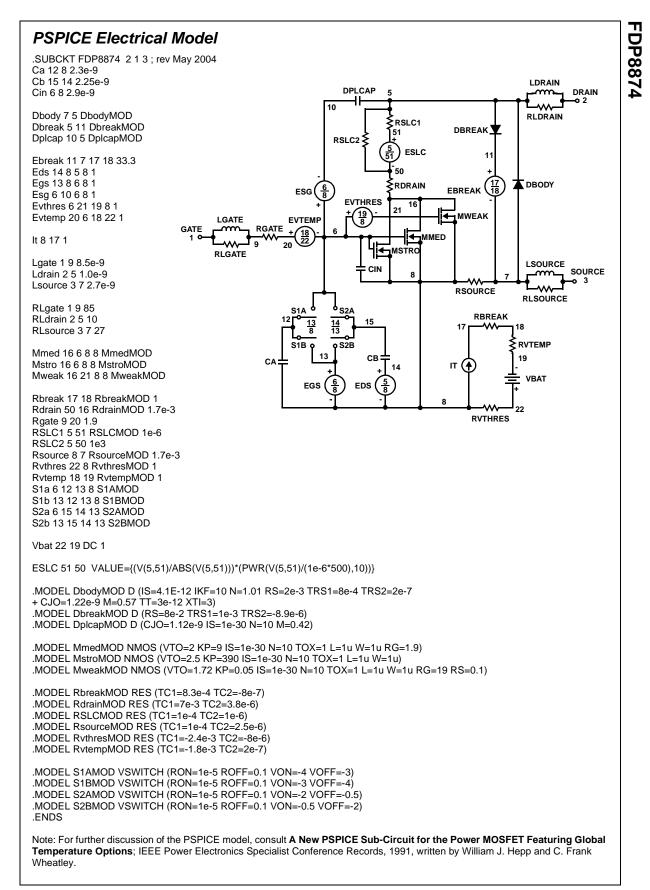
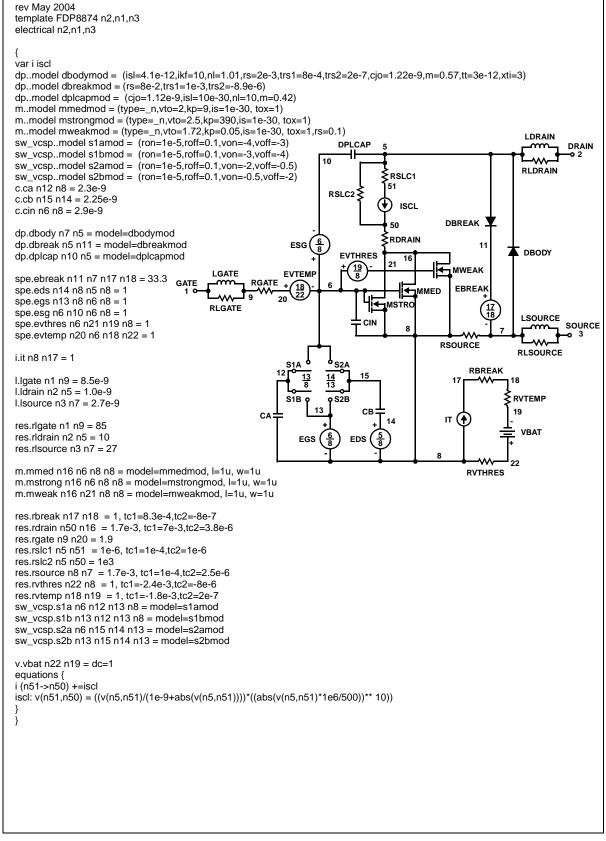
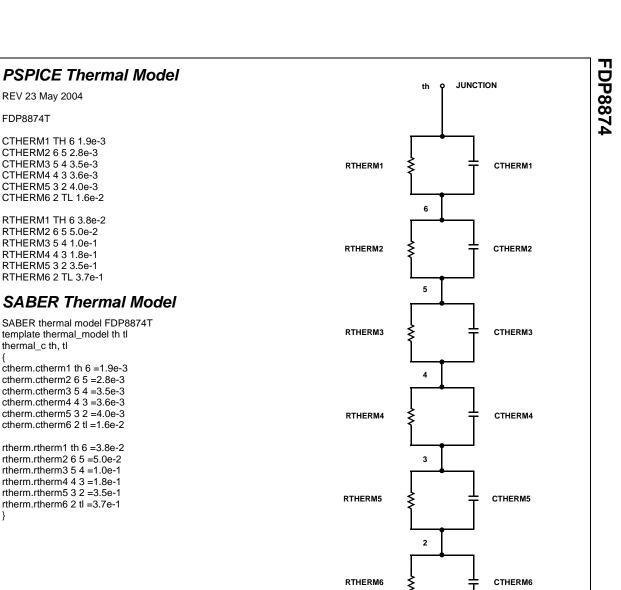


Figure 20. Switching Time Waveforms



SABER Electrical Model





CASE

tl Y

REV 23 May 2004

CTHERM1 TH 6 1.9e-3 CTHERM2 6 5 2.8e-3 CTHERM3 5 4 3.5e-3

CTHERM4 4 3 3.6e-3 CTHERM5 3 2 4.0e-3 CTHERM6 2 TL 1.6e-2

RTHERM1 TH 6 3.8e-2 RTHERM2 6 5 5.0e-2 RTHERM3 5 4 1.0e-1

RTHERM4 4 3 1.8e-1 RTHERM5 3 2 3.5e-1 RTHERM6 2 TL 3.7e-1

thermal_c th, tl

rtherm.rtherm6 2 tl =3.7e-1

}

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